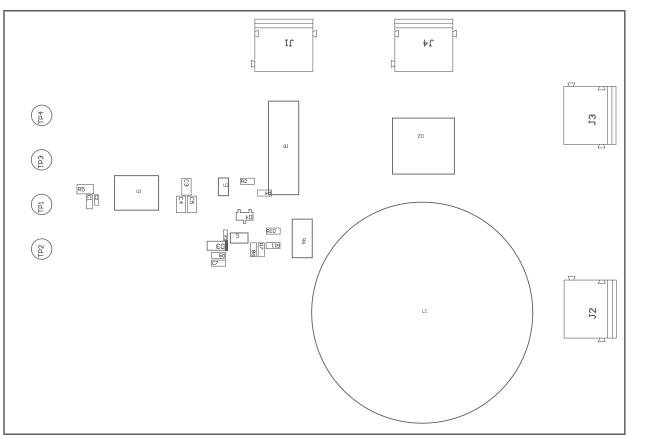
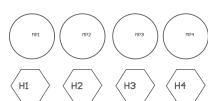
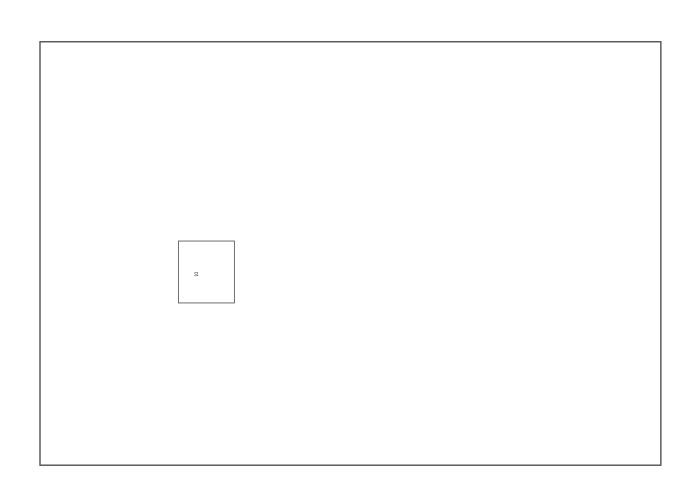
- ZZ7 UL E-file number must be on the board.
- ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
- ZZ6 Make sure that the plastic stand off bumps are high enough to avoid contact of though hole components with surfaces.
- ZZ5 Lead cutting after soldering. The cutting of component leads or wires after soldering shall be followed by the re-flow of the solder connection.





COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: T	IDA-050063	REV: E1	SUN REU:	: Not in version control
	TID #: T	IDA-050063			
PLOT NAME = Top Assembly Drawing	GENERATED	: 12/16/20	022 6:16:50	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-050063 REV: E1	SUN REV: Not in version control
	TID #: TIDA-050063	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/16/2022 6:16:50 PM	TEXAS INSTRUMENTS

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